PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|---------------------|----------------|
| Shunji MAEDA | 06/23/2011 |
| Kaoru SAKAI | 06/23/2011 |
| Hidetoshi NISHIYAMA | 06/30/2011 |

RECEIVING PARTY DATA

| Name: | Hitachi High-Technologies Corporation | |
|-------------------|---------------------------------------|--|
| Street Address: | 24-14, Nishishinbashi 1-chome | |
| Internal Address: | Minato-ku | |
| City: | Tokyo | |
| State/Country: | JAPAN | |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 13141375 |

CORRESPONDENCE DATA

Fax Number: (703)312-6666

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 703-312-6600
Email: rperez@antonelli.com

Correspondent Name: ANTONELLI, TERRY, STOUT & KRAUS, LLP Address Line 1: 1300 NORTH SEVENTEENTH STREET

Address Line 2: SUITE 1800

Address Line 4: ARLINGTON, VIRGINIA 22209-3873

| ATTORNEY DOCKET NUMBER: | 520.51742X00 |
|-------------------------|--------------|
| NAME OF SUBMITTER: | Melvin Kraus |

Total Attachments: 1

source=Assignment#page1.tif

PATENT
REEL: 026648 FRAME: 0988

OP \$40,00 1314137

ASSIGNMENT (譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan,

located at 24-14, Nishishinbashi 1-chome, Minato-ku, Tokyo, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said. Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

DEFECT INSPECTION METHOD AND DEVICE THEREOF

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi High-Technologies Corporation,

14 15 15 15 CO (C)

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside our signatures:

| INVENTOR(S) (発明者フルネームサイン) | | Date Signed (署名日) | |
|------------------------------|--|----------------------|--|
| 1)_ | Sheryt Mareda Shunji MAEDA | June 23, 21/ | |
| 2)_ | Shunji Maeda Shunji MAEDA Kaoru Aakai Kaoru SAKAI | 6/23/11 | |
| 3)_ | Hidotoshi nishiyama Hidetoshi NISHIYAMA | 6/30/11 | |
| 4)_ | | | |
| 5)_ | | | |
| 6)_ | | | |
| 7)_ | | | |
| 8)_ | | | |
| 9) | | | |
| | | | |

PATENT REEL: 026648 FRAME: 0989

RECORDED: 07/26/2011